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U.S. DEPARTMENT OF COMMERCE
Patent and Trademark Office



101160796

Tab settings

To the Honorable Commissioner of Patents

See the attached original documents or copy thereof.

1. Name of conveying party(ies):

Koki Hirasawa
Teruo Ono

MRO

9-22-99

2. Name and address of receiving party(ies):

Name: NEC Corporation

Address: 7-1, Shiba, 5-chome, Minato-ku

Additional names(s) of conveying party(ies)

Yes No

3. Nature of conveyance:

- Assignment Merger
- Security Agreement Change of Name
- Other

Execution Date: September 13, 1999

City: Tokyo State/Prov.:
Country: JAPAN ZIP:

Additional name(s) & address(es) Yes No

4. Application number(s) or registration numbers(s):

09/401,789

If this document is being filed together with a new application, the execution date of the application is: September 13, 1999

Patent Application No. Filing date

B. Patent No.(s)

Additional numbers

Yes No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Sean M. McGinn, Esq.

Registration No. 34,386 09401789

Address: McGinn & Gibb, P.C. 40.00 OP

1701 Clarendon Blvd., Suite 100

City: Arlington State/Prov.: VA

Country: USA ZIP: 22209

6. Total number of applications and patents involved:

1

7. Total fee (37 CFR 3.41): \$ 40.00

- Enclosed - Any excess or insufficiency should be credited or debited to deposit account
- Authorized to be charged to deposit account

8. Deposit account number:

50-0481

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Frederick W. Gibb, III

September 22, 1999

Name of Person Signing

Signature

Date

Total number of pages including cover sheet, attachments, and

3

ASSIGNMENT OF APPLICATION FOR PATENT

WHEREAS

NAME AND ADDRESS OF ASSIGNOR Koki Hirasawa, Tokyo, Japan and
Teruo Ono, Kagoshima, Japan

(HEREINAFTER REFERRED TO AS ASSIGNOR), have invented and own a certain new and useful invention entitled:

TITLE OF INVENTION: Multilayered Wiring Structure and
Method of Manufacturing the Same

WHEREAS

FULL NAME AND ADDRESS OF ASSIGNEE NEC CORPORATION
7-1, Shiba 5-chome, Minato-ku, Tokyo, Japan, and
Fuchigami Micro Co., Ltd.,
3-1, Nan'ei, Kagoshima-shi, Kagoshima, Japan

(hereinafter referred to as ASSIGNEE), is desirous of acquiring the entire right, title, and interest in, to and under said invention and the United States Letters Patent to be obtained therefor:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that in consideration of the payment of ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration, ASSIGNOR, by these presents, hereby sells, assigns and transfers to ASSIGNEE the entire and exclusive right, title and interest to said invention and all Letters Patent of the United States to be obtained therefor on said application or any continuation, division, renewal, substitute or reissue thereof for the full term or terms for which the same may be granted.

ASSIGNOR hereby authorizes and requests the Commissioner of Patents and Trademarks to issue said Letters Patent of the United States Patent obtained therefor on said application or any

continuation, division, renewal, substitute or reissue thereof for the full term or terms to said ASSIGNEE, of the entire right, title, and interest in and to the same, for his sole use and behoof, and for the use and behoof of his legal representatives, to the full end of the term or terms for which said Letters Patent obtained therefor on said application or any continuation, division, renewal, substitute or reissue thereof for may be granted, as full and entirely as the same would have been held by ASSIGNOR had this assignment and sale not been made.


ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale;

ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent as may be known and accessible to ASSIGNOR and will testify as to the same in any interference or litigation related thereto and will promptly execute and deliver to ASSIGNEE or its legal representative any and all papers, instruments or affidavits required to apply for, obtain, maintain and enforce said application, said invention and said Letters Patent which may be necessary or desirable to carry out the purposes hereof.


DATE OF SIGNING

IN WITNESS WHEREOF, I/We have hereunto set hand and seal this 13th day of September, 1999 .

SIGNATURE

By: Koki Hirasawa 
Koki Hirasawa


SIGNATURE

By: Teruo Ono 
Teruo Ono

SIGNATURE

By: _____

WITNESSES

[Signature] 
上田 亨

(Assignment of Application for Patent -- page 2 of 2)